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This journal invites original research and review papers that address the following issues in materials sciences and applications. Topics of interest include, but are not limited to:

- Biological, Biomechanical and Biomedical Materials
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- Electrical and Electronics Materials
- Fibers and Matrix Materials
- Functional Materials, including Shape Memory Materials, Self Healing Materials, etc.
- Light Emitting Material
- Magnetic Material
- Materials Chemistry
- Metals and Alloys
- Nanocomposites
- Nanomaterials including Nanostructured and Nanoscale Materials
- Nanosensors
- Nanostructured Materials
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- Rubber/Elastomeric Materials
- Semiconductor Materials
- Textile Materials
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